LNJ276CK2AA

Round Type

 $\phi 3.2 \ mm$

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	80	mW	
Forward current	I _F	30	mA	
Pulse forward current *	I _{FP}	100	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

Lighting Color

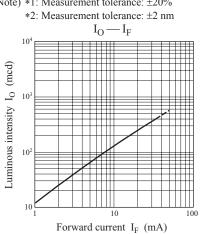
• Red

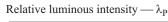
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

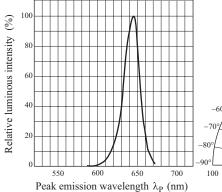
Electro-Optical Characteristics $T_a = 25^{\circ}C$

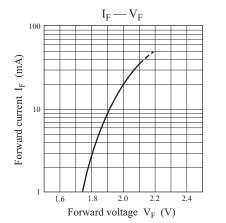
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	Io	$I_F = 20 \text{ mA}$	130	260		mcd
Reverse current	I _R	$V_R = 4 V$			100	μΑ
Forward voltage	V _F	$I_F = 20 \text{ mA}$		2.0	2.6	V
Dominant emission wavelength *2	λ_d	$I_F = 20 \text{ mA}$		632		nm
Peak emission wavelength	λ_{P}	$I_F = 20 \text{ mA}$		645		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$		17		nm

Note) *1: Measurement tolerance: ±20%

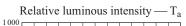


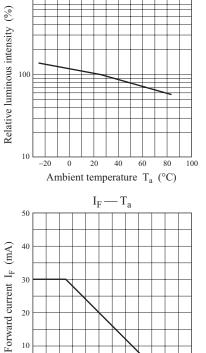






Directive characteristics





60 80

Ambient temperature T_a (°C)

20 0

20 40 60 80 100

80 60 40

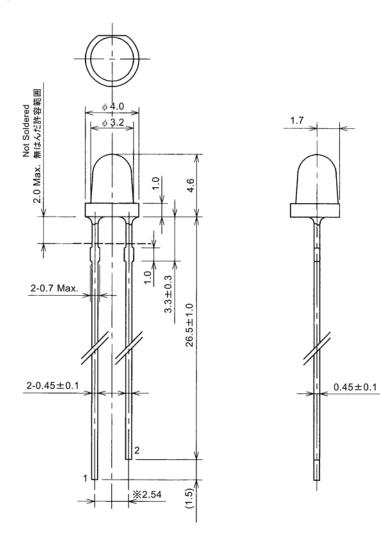
80°

0

20 40

100 120

Package (Unit: mm)



• Pin name

1: Anode

2: Cathode

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